WORLDWIDE OSAT MANUFACTURING SITES DATABASE, 2019 EDITION

SERVICES — TECHNOLOGIES — APPLICATIONS

The Worldwide OSAT Manufacturing Sites Database is a comprehensive report tracking over 360 back-end facilities that provide outsourced semiconductor assembly and testing manufacturing services in China, Taiwan, Korea, Japan, Southeast Asia, Europe, and the Americas. The Worldwide OSAT Manufacturing Sites Database is an essential business tool for anyone interested in the semiconductor back-end supply chain.

Details include:

- Plant site technology capability: Tape and Reel, Test
- Packaging assembly service offered: BGA, specific leadframe type such as QFP, QFN, SO, flip chip bumping, WLP, Modules/SIP, etc.
- Plant site specialization: TSV, RF, Cu Pillar, RDL, etc.

FEATURES

- Manufacturing site information
- Packaging technology capability available
- Plant site applications capabilities
- Type of services offered
- Manufacturing specialization by facility

BENEFITS

- Gain insight to worldwide OSAT facilities capabilities and expertise
- Understand key packaging capabilities and technologies by OSAT
- Identify business opportunities and competitive analysis reference

2020 PRICING INFORMATION

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